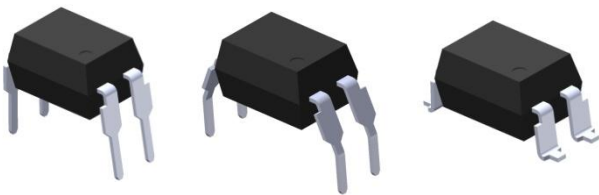


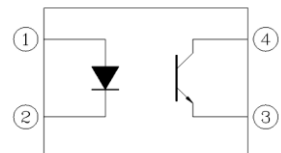
4 PIN DIP PHOTOTRANSISTOR PHOTOCOUPLER EL817 Series



Features:

- Current transfer ratio (CTR: 50~600% at $I_F = 5\text{mA}$, $V_{CE} = 5\text{V}$)
- High isolation voltage between input and output ($V_{iso} = 5000\text{V}_{rms}$)
- Creepage distance $> 7.62\text{mm}$
- Operating temperature up to $+110^\circ\text{C}$
- Compact small outline package
- The product itself will remain within RoHS compliant version
- Compliance with EU REACH
- UL and cUL approved (No. E214129)
- VDE approved (No. 132249)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CQC approved

Schematic



Pin Configuration

1. Anode
2. Cathode
3. Emitter
4. Collector

Description

The EL817 series of devices each consist of an infrared emitting diodes, optically coupled to a phototransistor detector. They are packaged in a 4-pin DIP package and available in wide-lead spacing and SMD option.

Applications

- Programmable controllers
- System appliances, measuring instruments
- Telecommunication equipments
- Home appliances, such as fan heaters, etc.
- Signal transmission between circuits of different potentials and impedances

Absolute Maximum Ratings (Ta=25°C)

| | Parameter | Symbol | Rating | Unit |
|-------------------------------------|---|------------|------------|-------------|
| Input | Forward current | I_F | 60 | mA |
| | Peak forward current (1us, pulse) | I_{FP} | 1 | A |
| | Reverse voltage | V_R | 6 | V |
| | Power dissipation Derating factor (above $T_a = 100^\circ\text{C}$) | P_D | 100 2.9 | mW mW/°C |
| Output | Power dissipation Derating factor (above $T_a = 100^\circ\text{C}$) | P_C | 150 5.8 | mW mW/°C |
| | Collector current | I_C | 50 | mA |
| | Collector-Emitter voltage | V_{CEO} | 35 | V |
| | Emitter-Collector voltage | V_{ECO} | 6 | V |
| | Total Power Dissipation | P_{TOT} | 200 | mW |
| Isolation Voltage* ¹ | V_{ISO} | 5000 | V rms | |
| Operating Temperature | T_{OPR} | -55 to 110 | °C | |
| Storage Temperature | T_{STG} | -55 to 125 | °C | |
| Soldering Temperature* ² | T_{SOL} | 260 | °C | |

Notes:

*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2 are shorted together, and pins 3, 4 are shorted together.

*2 For 10 seconds

Electro-Optical Characteristics (Ta=25°C unless specified otherwise)

Input

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Condition |
|-------------------|----------|------|------|------|---------------|--------------------------|
| Forward Voltage | V_F | - | 1.2 | 1.4 | V | $I_F = 20\text{mA}$ |
| Reverse Current | I_R | - | - | 10 | μA | $V_R = 4\text{V}$ |
| Input capacitance | C_{in} | - | 30 | 250 | pF | $V = 0, f = 1\text{kHz}$ |

Output

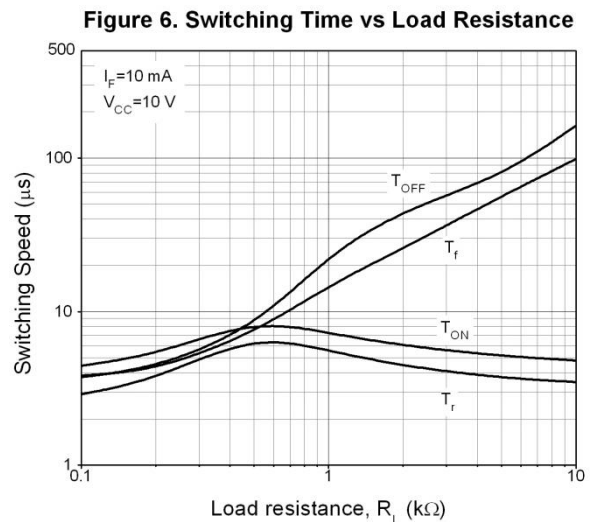
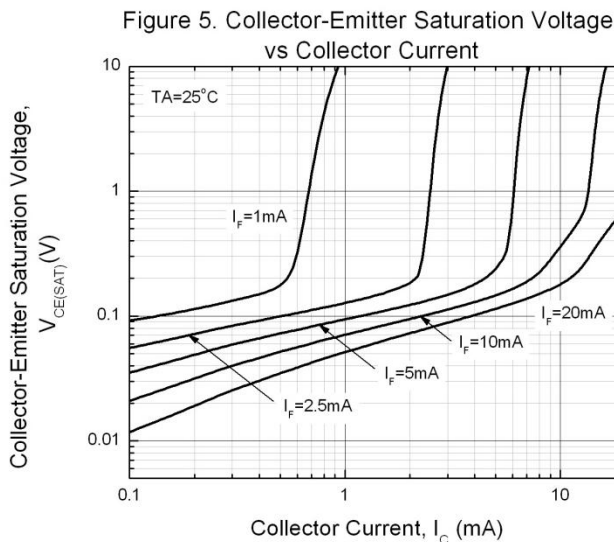
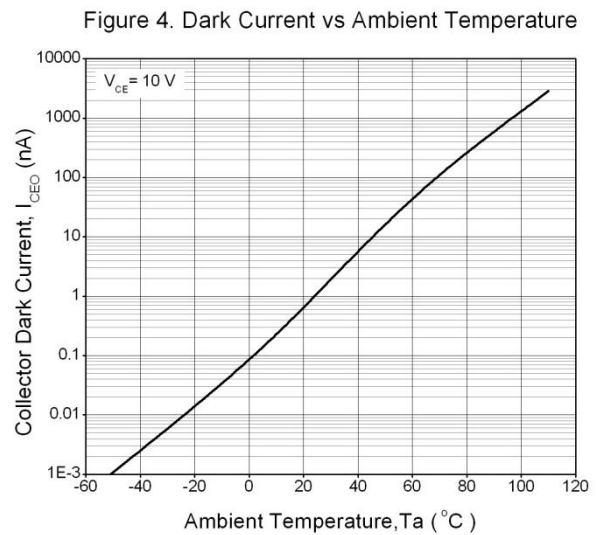
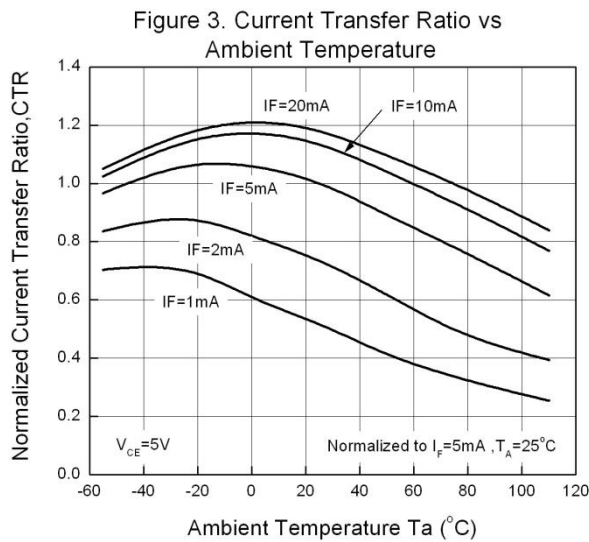
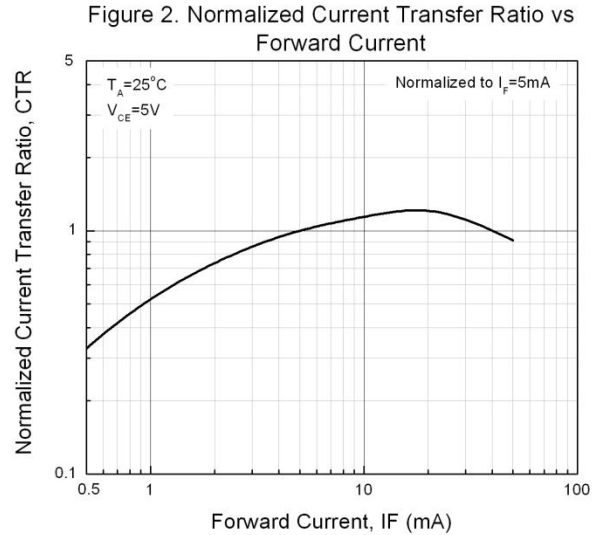
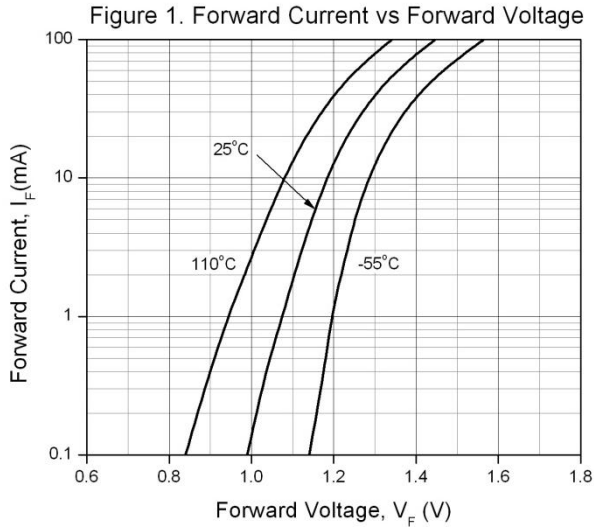
| Parameter | Symbol | Min | Typ. | Max. | Unit | Condition |
|-------------------------------------|------------|-----|------|------|------|---|
| Collector-Emitter dark current | I_{CEO} | - | - | 100 | nA | $V_{CE} = 20\text{V}, I_F = 0\text{mA}$ |
| Collector-Emitter breakdown voltage | BV_{CEO} | 35 | - | - | V | $I_C = 0.1\text{mA}$ |
| Emitter-Collector breakdown voltage | BV_{ECO} | 6 | - | - | V | $I_E = 0.1\text{mA}$ |

Transfer Characteristics

| Parameter | Symbol | Min | Typ. | Max. | Unit | Condition |
|--------------------------------------|---------------|--------------------|------|------|---------------|--|
| Current Transfer ratio | EL817 | 50 | - | 600 | % | $I_F = 5\text{mA}, V_{CE} = 5\text{V}$ |
| | EL817A | 80 | - | 160 | | |
| | EL817B | 130 | - | 260 | | |
| | EL817C | 200 | - | 400 | | |
| | EL817D | 300 | - | 600 | | |
| | EL817X | 100 | - | 200 | | |
| | EL817Y | 150 | - | 300 | | |
| Collector-Emitter saturation voltage | $V_{CE(sat)}$ | - | 0.1 | 0.2 | V | $I_F = 20\text{mA}, I_C = 1\text{mA}$ |
| Isolation resistance | R_{IO} | 5×10^{10} | - | - | Ω | $V_{IO} = 500\text{Vdc}, 40\sim 60\% \text{ R.H.}$ |
| Floating capacitance | C_{IO} | - | 0.6 | 1.0 | pF | $V_{IO} = 0, f = 1\text{MHz}$ |
| Cut-off frequency | f_c | - | 80 | - | kHz | $V_{CE} = 5\text{V}, I_C = 2\text{mA}$ $R_L = 100\Omega, -3\text{dB}$ |
| Rise time | t_r | - | - | 18 | μs | $V_{CE} = 2\text{V}, I_C = 2\text{mA}, R_L = 100\Omega$ |
| Fall time | t_f | - | - | 18 | μs | |

* Typical values at $T_a = 25^\circ\text{C}$

Typical Electro-Optical Characteristics Curves



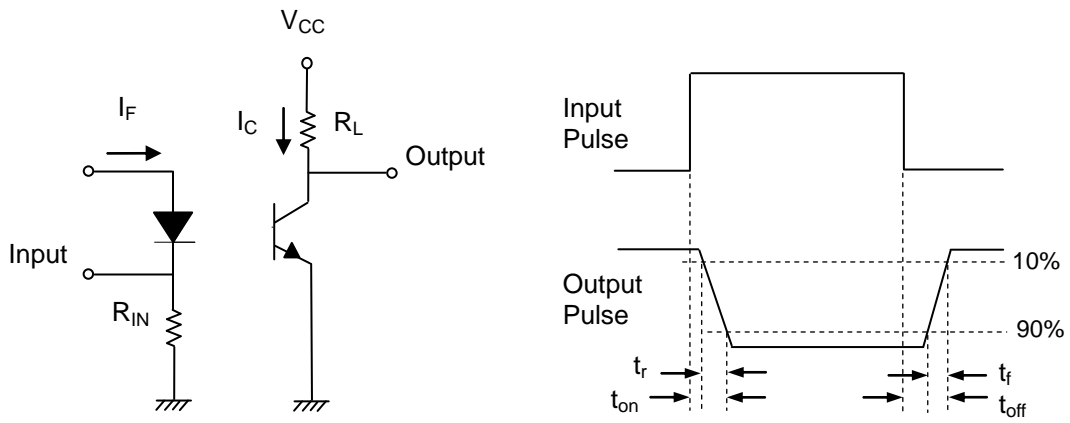


Figure 7. Switching Time Test Circuit & Waveforms

Order Information

Part Number

EL817X(Y)(Z)-FV

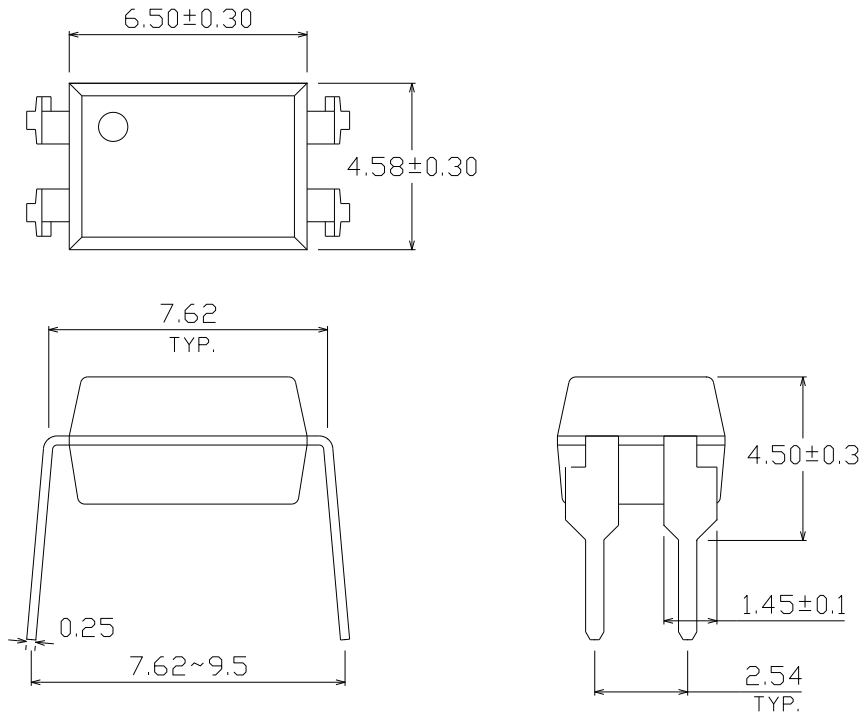
Note

- X = Lead form option (S, S1, S2, M or none)
- Y = CTR Rank (A, B, C, D, X, Y or none)
- Z = Tape and reel option (TA, TB, TU, TD or none)
- F = Lead frame option (F: Iron, None: copper)
- V = VDE safety (optional).

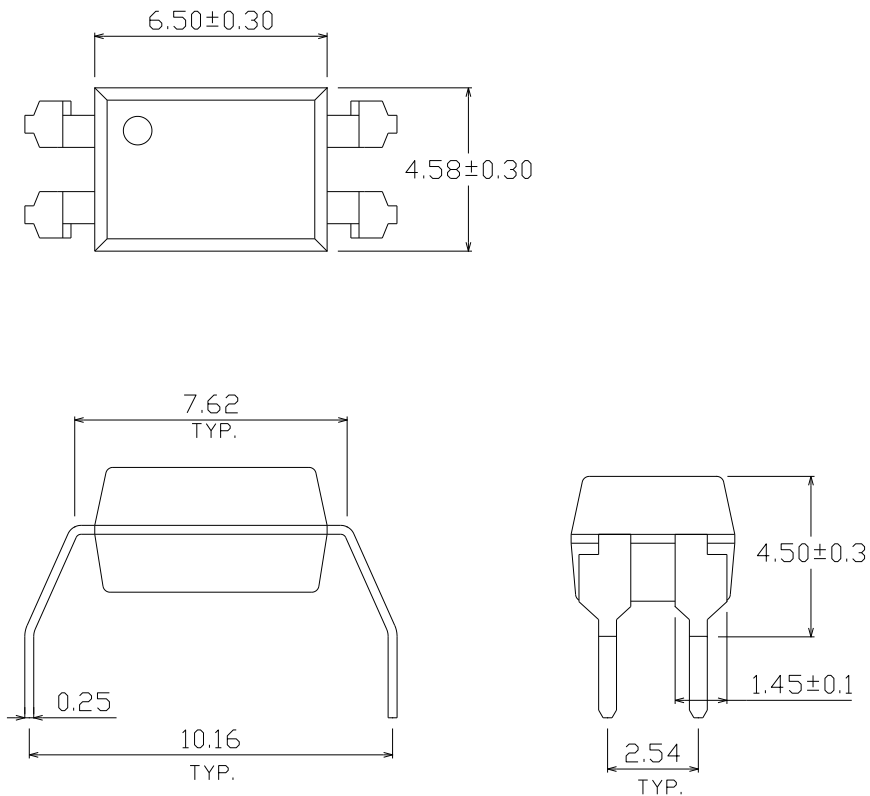
| Option | Description | Packing quantity |
|---------|---|---------------------|
| None | Standard DIP-4 | 100 units per tube |
| M | Wide lead bend (0.4 inch spacing) | 100 units per tube |
| S (TA) | Surface mount lead form + TA tape & reel option | 1000 units per reel |
| S (TB) | Surface mount lead form + TB tape & reel option | 1000 units per reel |
| S1 (TA) | Surface mount lead form (low profile) + TA tape & reel option | 1000 units per reel |
| S1 (TB) | Surface mount lead form (low profile) + TB tape & reel option | 1000 units per reel |
| S2 (TA) | Surface mount lead form (Gull-wing) + TA tape & reel option | 1000 units per reel |
| S2 (TB) | Surface mount lead form (Gull-wing) + TB tape & reel option | 1000 units per reel |
| S (TU) | Surface mount lead form + TU tape & reel option | 1500 units per reel |
| S (TD) | Surface mount lead form + TD tape & reel option | 1500 units per reel |
| S1 (TU) | Surface mount lead form (low profile) + TU tape & reel option | 1500 units per reel |
| S1 (TD) | Surface mount lead form (low profile) + TD tape & reel option | 1500 units per reel |
| S2 (TU) | Surface mount lead form (low profile) + TU tape & reel option | 2000 units per reel |
| S2 (TD) | Surface mount lead form (low profile) + TD tape & reel option | 2000 units per reel |

Package Dimension (Dimensions in mm)

Standard DIP Type



Option M Type



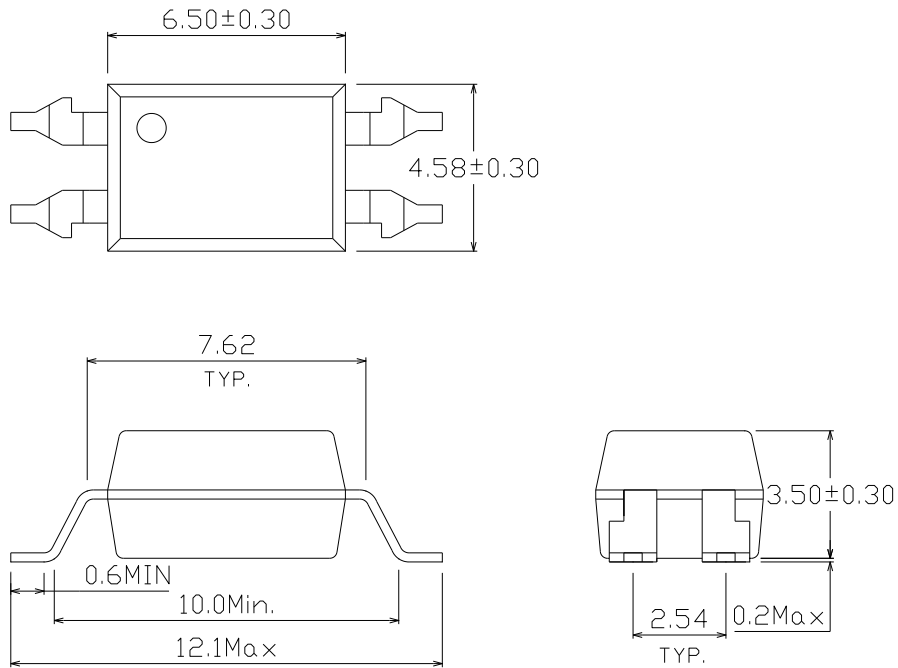
Option S Type



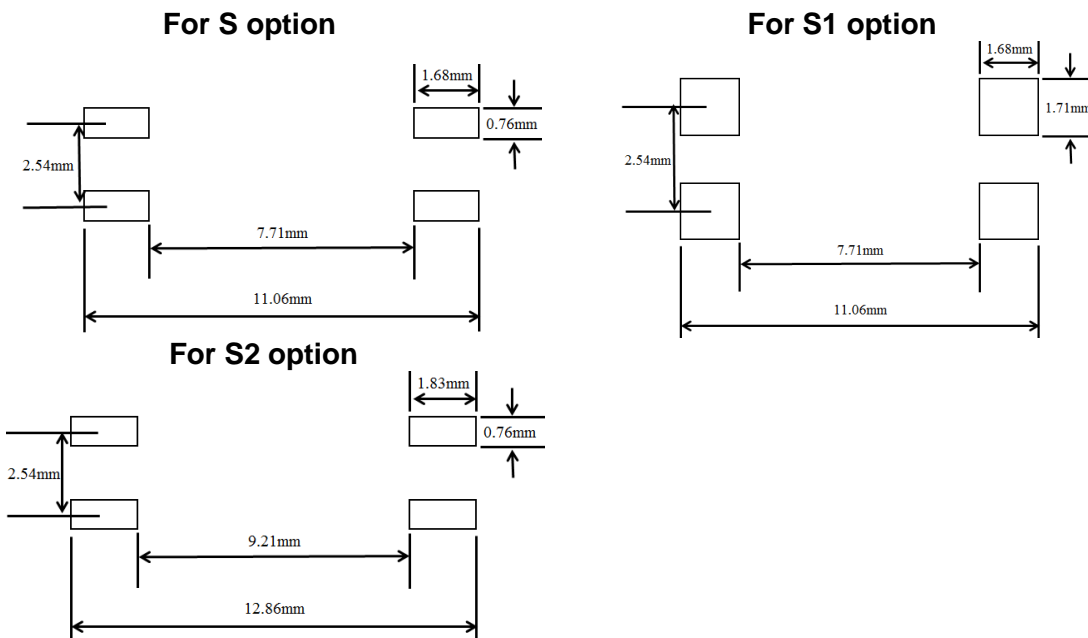
Option S1 Type



Option S2 Type



Recommended pad layout for surface mount leadform



Notes

Suggested pad dimension is just for reference only.
Please modify the pad dimension based on individual need.

Device Marking

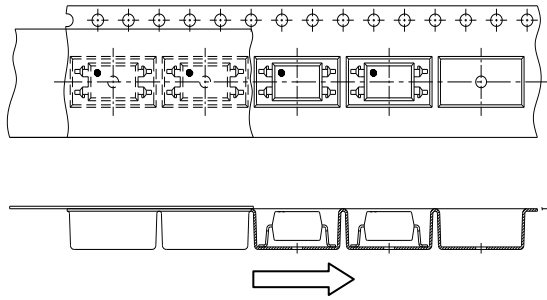


Notes

| | |
|-----|--|
| EL | denotes EVERLIGHT |
| 817 | denotes Device Number |
| F | denotes Factory Code (G: China and Green part) |
| R | denotes CTR Rank (A, B, C, D, X, Y or none) |
| Y | denotes 1 digit Year code |
| WW | denotes 2 digit Week code |
| V | denotes VDE (optional) |

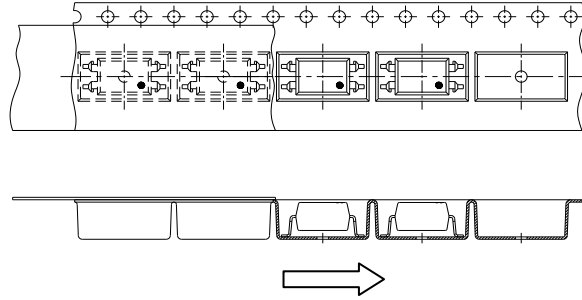
Tape & Reel Packing Specifications

Option TA



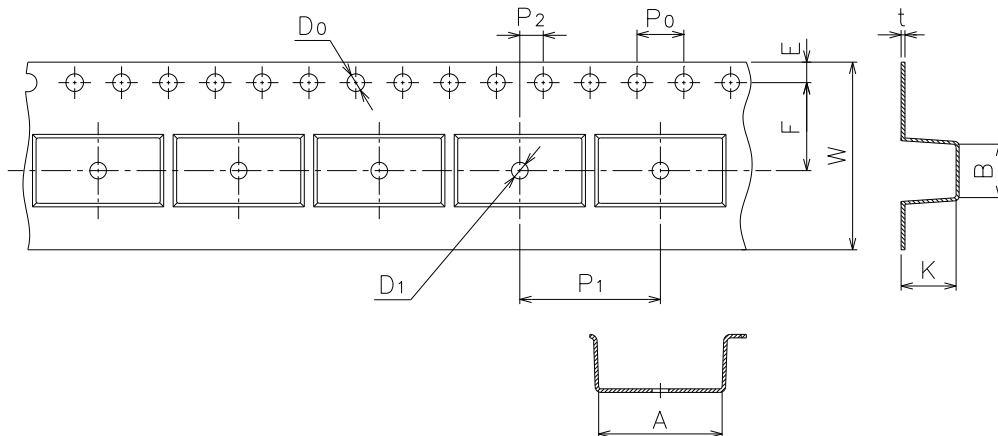
Direction of feed from reel

Option TB



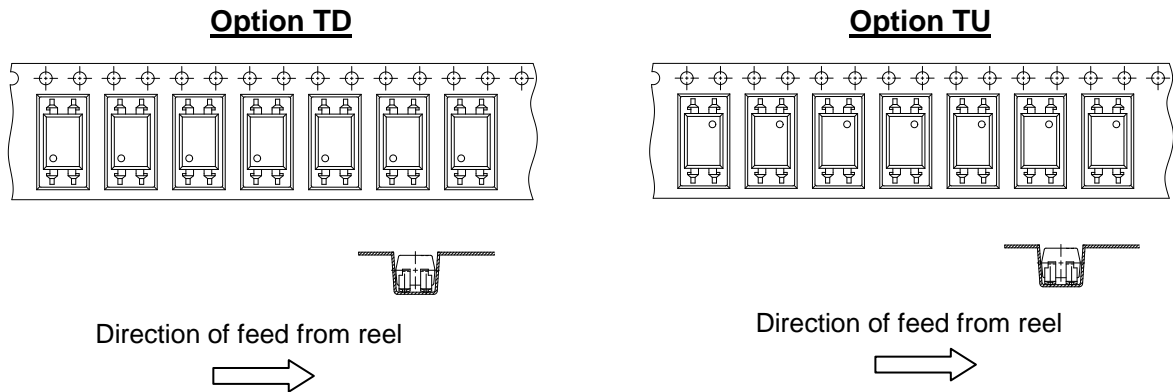
Direction of feed from reel

Tape dimensions

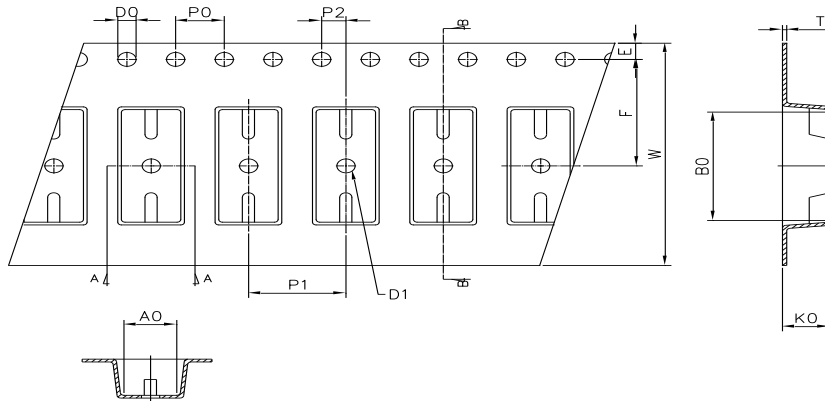


| | | | | | | |
|----------------------|-----------|-----------|-----------|-----------|----------|----------|
| Dimension No. | A | B | Do | D1 | E | F |
| Dimension (mm) S | 10.7±0.1 | 4.65±0.1 | 1.5±0.1 | 1.50±0.1 | 1.75±0.1 | 7.5±0.1 |
| Dimension (mm) S1 | 10.7±0.1 | 4.65±0.1 | 1.5±0.1 | 1.50±0.1 | 1.75±0.1 | 7.5±0.1 |
| Dimension (mm) S2 | 12.15±0.1 | 4.65±0.1 | 1.5±0.1 | 1.50±0.1 | 1.75±0.1 | 7.5±0.1 |
| Dimension No. | Po | P1 | P2 | t | W | K |
| Dimension (mm) S | 4.0±0.1 | 12.0±0.1 | 2.0±0.1 | 0.4±0.1 | 16.0±0.3 | 4.75±0.1 |
| Dimension (mm) S1 | 4.0±0.1 | 12.0±0.1 | 2.0±0.1 | 0.4±0.1 | 16.0±0.3 | 3.90±0.1 |
| Dimension (mm) S2 | 4.0±0.1 | 16.0±0.1 | 2.0±0.1 | 0.4±0.1 | 16.0±0.3 | 3.90±0.1 |

Tape & Reel Packing Specifications



Tape dimensions

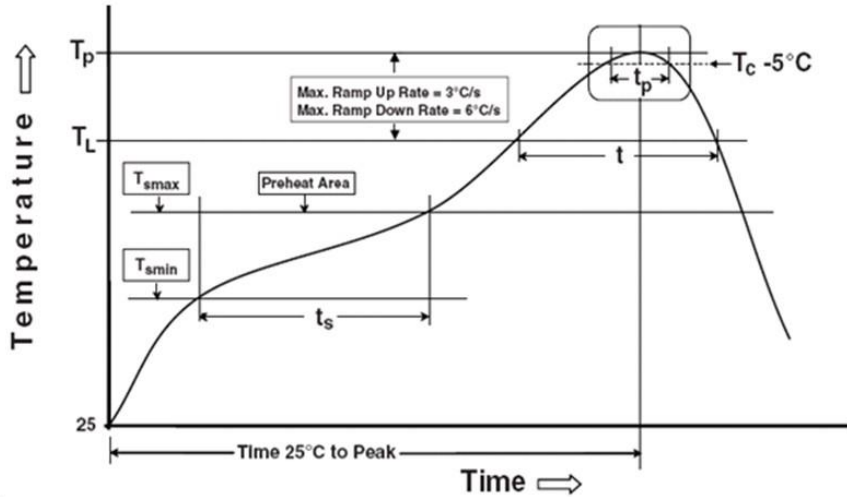


| Dimension No. | Ao | Bo | Do | D1 | E | F |
|------------------------|-----------|-----------|-----------|-----------|-----------|-----------|
| Dimension (mm) S.S1 | 4.90±0.1 | 10.40±0.1 | 1.5±0.1 | 1.50±0.1 | 1.75±0.1 | 7.50±0.1 |
| Dimension (mm) S2 | 4.88±0.1 | 12.55±0.1 | 1.5±0.1 | 1.50±0.1 | 1.75±0.1 | 11.5±0.1 |
| Dimension No. | Po | P1 | P2 | t | W | Ko |
| Dimension (mm) S.S1 | 4.00±0.1 | 8.00±0.1 | 2.00±0.1 | 0.40±0.1 | 16.00±0.3 | 4.60±0.1 |
| Dimension (mm) S2 | 4.00±0.1 | 8.00±0.1 | 2.00±0.1 | 0.40±0.1 | 24.00±0.3 | 4.00±0.1 |

Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Reference: IPC/JEDEC J-STD-020D

Preheat

| | |
|--|-----------------|
| Temperature min (T_{smin}) | 150 °C |
| Temperature max (T_{smax}) | 200°C |
| Time (T_{smin} to T_{smax}) (t_s) | 60-120 seconds |
| Average ramp-up rate (T_{smax} to T_p) | 3 °C/second max |

Other

| | |
|--|------------------|
| Liquidus Temperature (T_L) | 217 °C |
| Time above Liquidus Temperature (t_L) | 60-100 sec |
| Peak Temperature (T_p) | 260°C |
| Time within 5 °C of Actual Peak Temperature: $T_p - 5^\circ\text{C}$ | 30 s |
| Ramp- Down Rate from Peak Temperature | 6°C /second max. |
| Time 25°C to peak temperature | 8 minutes max. |
| Reflow times | 3 times |

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2. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
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